TIDA-00640 REV E1 Bill of Materials

Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
!PCB1	1		TIDA-00640	Any	Printed Circuit Board	
C1, C2, C3, C5, C6, C8, C9	7	0.1uF	GRM155R70J104KA01D	MuRata	CAP, CERM, 0.1 µF, 6.3 V, +/- 10%, X7R, 0402	0402
C4, C10, C11	3	1uF	GRM155R61A105KE15D	MuRata	CAP, CERM, 1 µF, 10 V, +/- 10%, X5R, 0402	0402
C7	1	220pF	GRM1555C1H221JA01D	MuRata	CAP, CERM, 220 pF, 50 V, +/- 5%, C0G/NP0, 0402	0402
C12, C13	2	22pF	GRM1555C1H220JA01D	MuRata	CAP, CERM, 22 pF, 50 V, +/- 5%, C0G/NP0, 0402	0402
C14, C15	2	DNP	0402YC132KAT2A	AVX	CAP, CERM, 1300 pF, 16 V, +/- 10%, X7R, 0402	0402
C16, C17	2	12pF	GRM1555C1H120JA01D	MuRata	CAP, CERM, 12 pF, 50 V, +/- 5%, C0G/NP0, 0402	0402
C18	1	0.01uF	GRM155R61C103KA01D	MuRata	CAP, CERM, 0.01 µF, 16 V, +/- 10%, X5R, 0402	0402
C19	1	1uF	GRM188R61C105KA93D	MuRata	CAP, CERM, 1 µF, 16 V, +/- 10%, X5R, 0603	0603
C20	1	10uF	GRM188R60J106ME47D	MuRata	CAP, CERM, 10 µF, 6.3 V, +/- 20%, X5R, 0603	0603
C21	1	750pF	GRM1555C1H751JA01D	MuRata	CAP, CERM, 750 pF, 50 V, +/- 5%, C0G/NP0, 0402	0402
C22, C25	2	2.2uF	GRM32ER72A225KA35L	MuRata	CAP, CERM, 2.2 µF, 100 V, +/- 10%, X7R, 1210	1210
C23	1	1000pF	GRM155R71H102KA01D	MuRata	CAP, CERM, 1000 pF, 50 V, +/- 10%, X7R, 0402	0402
C24	1	0.1uF	C0402C104K4RACAUTO	Kemet	CAP, CERM, 0.1 µF, 16 V, +/- 10%, X7R, AEC-Q200 Grade 1, 0402	0402
DEBUG	1		FTSH-105-01-L-DV-K	Samtec	Header(Shrouded), 1.27mm, 5x2, Gold, SMT	Header(Shrouded), 1.27mm, 5x2, SMT
E1	1		ANTENNA_DN007A	N/A	2.4GHz PCB Antenna. There is nothing to buy or mount.	SMD, 3-Leads
FL1	1	2.45 GHz	LFB182G45BG5D920	MuRata	Filter, BandPass, 2.45GHz, SMD	1.6x0.8mm
J1, J2, J3, J4	4		1727010	Phoenix Contact	Conn Term Block, 2POS, 3.81mm, TH	2POS Terminal Block
J5	1		0022284043	Molex	Header, 2.54mm, 4x1, Tin, TH	Header, 2.54mm, 4x1, TH
L1	1	330uH	LPS5030-334MLB	Coilcraft	Inductor, Shielded Drum Core, Ferrite, 330 µH, 0.2 A, 1.8 ohm, SMD	LPS5030
LBL1	1		THT-14-423-10	Brady	Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	PCB Label 0.650"H x 0.200"W
R1	1	56.0k	RK73H1ETTP5602F	KOA Speer	RES, 56.0 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402	0402
R2	1	0	CRCW04020000Z0ED	Vishay-Dale	RES, 0, 5%, 0.063 W, 0402	0402
R3	1	1.15k	CRCW04021K15FKED	Vishay-Dale	RES, 1.15 k, 1%, 0.063 W, 0402	0402
R4	1	300k	CRCW0402300KFKED	Vishay-Dale	RES, 300 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402	0402
R5, R9	2	249k	CRCW1206249KFKEA	Vishay-Dale	RES, 249 k, 1%, 0.25 W, 1206	1206
R6	1	88.7k	CRCW040288K7FKED	Vishay-Dale	RES, 88.7 k, 1%, 0.063 W, 0402	0402
R7	1	51.1k	CRCW040251K1FKED	Vishay-Dale	RES, 51.1 k, 1%, 0.063 W, 0402	0402
R8	1	10.0k	CRCW040210K0FKED	Vishay-Dale	RES, 10.0 k, 1%, 0.063 W, 0402	0402
R10	1	13.0k	CRCW040213K0FKED	Vishay-Dale	RES, 13.0 k, 1%, 0.063 W, 0402	0402
R11	1	2.15	CRCW04022R15FKED	Vishay-Dale	RES, 2.15, 1%, 0.063 W, 0402	0402
R12	1	6.12k	RT0805BRD076K12L	Yageo America	RES, 6.12 k, 0.1%, 0.125 W, 0805	0805
R13	1	2.2k	CRCW04022K20JNED	Vishay-Dale	RES, 2.2 k, 5%, 0.063 W, 0402	0402
R14	1	10.0k	ERJ-6ENF1002V	Panasonic	RES, 10.0 k, 1%, 0.125 W, 0805	0805
RS1	1	0.001	LRMAP3920B-R001FT	TT Electronics/IRC	RES, 0.001, 1%, 4 W, AEC-Q200 Grade 0, 3920	3920
U1	1		CC2538NF11RTQR	Texas Instruments	A Powerful System-On-Chip for 2.4-GHz IEEE 802.15.4, 6LoWPAN and ZigBee Applications, RTQ0056F	RTQ0056C
U2	1		TLV342AID	Texas Instruments	Low-Voltage, Rail-To-Rail Output CMOS Operational Amplifier, 1.5 to 5.5 V, -40 to 125 degC, 8-pin SOIC (D0008A), Green (RoHS & no Sb/Br)	D0008A
U3	1		LM5017MRX/NOPB	Texas Instruments	100V, 600mA Constant On-Time Synchronous Buck Regulator, DDA0008B	DDA0008B
Y1	1		FC-12M 32.7680KA-A3	Epson	Crystal, 32.768kHz, 12.5pF, SMD	Crystal 2.05x.6x1.2mm
Y2	1		FA-128 32.0000MF20X-K3	Epson	Crystal, 32MHz, 10pF, SMD	1.6x.5x2mm
FID1, FID2, FID3	0		N/A	N/A	Fiducial mark. There is nothing to buy or mount.	Fiducial

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